

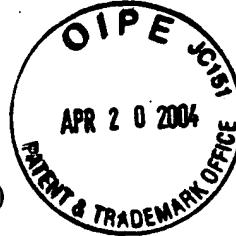


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

DONALD C. ABBOTT ET AL.

Serial No. 10/724,498 (TI-28098.1)



Filed: December 1, 2003

For: SEMICONDUCTOR CIRCUIT ASSEMBLY HAVING PLATED LEADFRAME
INCLUDING GOLD SELECTIVELY COVERING AREAS TO BE SOLDERED

Art Unit 2814

Examiner Wael M. Fahmy

Customer No. 23494

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4-19-04

Jay M. Cantor, Reg. No. 19,906

PRELIMINARY AMENDMENT

Dear Sir:

Prior to the first Office action and responsive to the Notice of Non-compliance dated March 25, 2004, please amend the above-identified application as follows: